

RF power transistor the LdmoST family

Technical Literature

CUSTOM ATTRIBUTES

Alternate Identifier(s) 7719

Key process Product Development

ISO Definition Specification

Confidentiality Level Public

Document Type Technical Literature

Document Category Datasheet

Document Family

Original ID

Original Repository

Status IN APPROVAL

Responsible

KeywordsTechnical Literature, 7719, Product Development,

Specification, Datasheet, SD57030,



DOCUMENT HISTORY

		DOCOMENT HISTORY	
V	ersion	Release Date	Change Qualifier
	7.2		Properties Changes
05/21/2013	AUTOMATIC REV	ALIDATION DATE WORKFLOW S	TARTED
			X.
		CX.	
)	

DOCUMENT APPROVAL

LABEL	USER FUNCTION	DATE
Camilleri Evelina	Document Controller	27-May-2013



SD57030

RF power transistor the LdmoST family

Features

- Excellent thermal stability
- Common source configuration
- P_{OUT} = 30W with 13dB gain @ 945MHz
- BeO free package
- Internal input matching
- In compliance with the 2002/95/EC european directive

Description

The SD57030 is a common source N-channel enhancement-mode lateral Field-Effect RF power transistor designed for broadband commercial and industrial applications at frequencies up to 1.0 GHz. The SD57030 is designed for high gain and broadband performance operating in common source mode at 28 V. It is ideal for base station applications requiring high linearity.

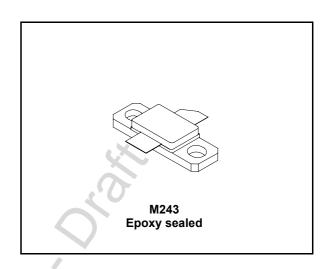


Figure 1. Pin connection

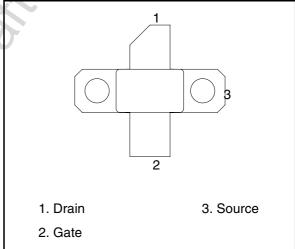


Table 1. Device summary

Order code	Package	Branding
SD57030	M243	SD57030

August 2007 Rev 7 1/11

www.st.com

Contents SD57030

Contents

1	Electrical data 3
	1.1 Maximum ratings 3
	1.2 Thermal data 3
2	Electrical characteristics4
	2.1 Static 4
	2.2 Dynamic
3	Typical performance (CW) 5
4	Test circuit
5	Text circuit layout 8
6	Package mechanical data 9
7	Revision history



Copyright STMicroelectronics

SD57030 Electrical data

1 Electrical data

1.1 Maximum ratings

Table 1. Absolute maximum ratings $(T_{CASE} = 25^{\circ}C)$

Symbol	Parameter	Value	Unit
V _{(BR)DSS}	Drain-Source voltage	65	V
V _{DGR}	Drain-Gate voltage ($R_{GS} = 1 \text{ M}\Omega$)	65	V
V _{GS}	Gate-Source voltage	+ 20	V
I _D	Drain current	4	Α
P _{DISS}	Power dissipation (@ Tc = 70°C)	74	W
Tj	Max. operating junction temperature	200	°C
T _{STG}	Storage temperature	-65 to + 200	°C

1.2 Thermal data

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Junction - case thermal resistance	1.75	°C/W



Electrical characteristics SD57030

2 Electrical characteristics

 $T_{CASE} = +25$ °C

2.1 Static

Table 3. Static (per section)

Symbol		Test conditions	Min	Тур	Max	Unit	
V _{(BR)DSS}	$V_{GS} = 0 V$	$I_{DS} = 10 \text{ mA}$		65			V
I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 28 V				1	μΑ
I _{GSS}	V _{GS} = 20 V	$V_{DS} = 0 V$				1	μΑ
V _{GS(Q)}	V _{DS} = 28 V	$I_D = 50 \text{ mA}$		2.0		5.0	V
V _{DS(ON)}	V _{GS} = 10 V	$I_D = 3 A$			1.3		V
G _{FS}	V _{DS} = 10 V	I _D = 3 A			1.8		mho
C _{ISS} ⁽¹⁾	$V_{GS} = 0 V$	V _{DS} = 28 V	f = 1 MHz		58		pF
Coss	$V_{GS} = 0 V$	V _{DS} = 28 V	f = 1 MHz		34		pF
C _{RSS}	V _{GS} = 0 V	V _{DS} = 28 V	f = 1 MHz		2.7		pF

^{1.} Includes Internal Input Moscap.

2.2 Dynamic

Table 4. Dynamic

Symbol	Test conditions	Min	Тур	Max	Unit
P _{OUT}	$V_{DD} = 28 \text{ V}$ $I_{DQ} = 50 \text{ mA}$ $f = 945 \text{ MHz}$	30			W
G _{PS}	$V_{DD} = 28 \text{ V}$ $I_{DQ} = 50 \text{ mA } P_{OUT} = 30 \text{ W}$ $f = 945 \text{ MHz}$	13	15		dB
h _D	$V_{DD} = 28 \text{ V}$ $I_{DQ} = 50 \text{ mA}$ $P_{OUT} = 30 \text{ W}$ $f = 945 \text{ MHz}$	50	60		%
Load mismatch	$V_{DD} = 28~V~~I_{DQ} = 50~mA~~P_{OUT} = 28~W~~f = 945~MHz$ All phase angles	10:1			VSWR

577

Copyright STMicroelectronics

3 Typical performance (CW)

Figure 2. Output power vs input power

Figure 3. Power gain and efficiency vs output power

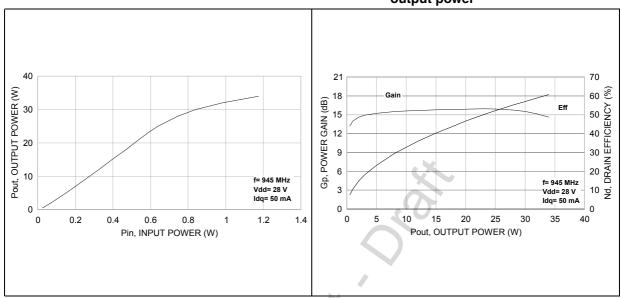
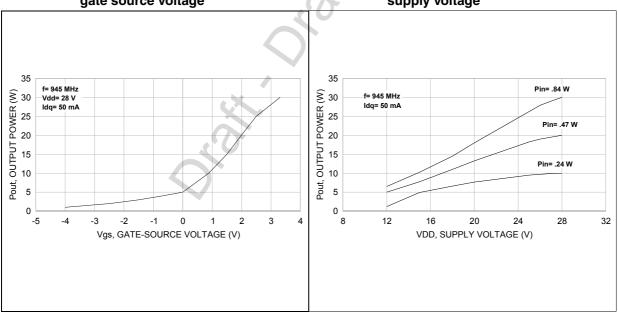


Figure 4. Output power vs gate source voltage

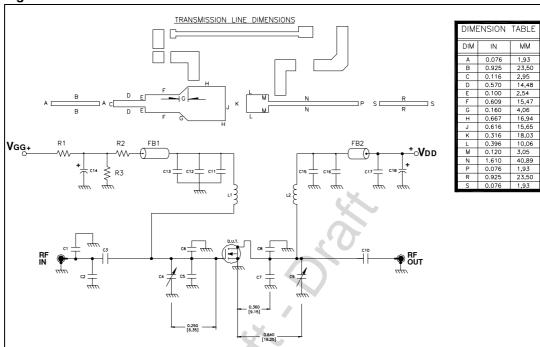
Figure 5. Output power vs supply voltage



Test circuit SD57030

4 Test circuit

Figure 6. Test circuit schematic



- 1 Dimensions at component symbols are reference for component placement.
- 2 Gap between ground & transmission line = 0.056 [1.42] +0.002 [0.05] -0.000 [0.00] typ.
- 3 Dimensions of input and output component from edge of transmission lines.

577

9 / 14

Copyright STMicroelectronics

SD57030 Test circuit

Table 5. Test circuit component part list

Component	Description
C19	200 μF / 63V ALLUMINIUM ELECTROLYTIC RADIAL LEAD CAPACITOR
C18, C14	0.1 μF / 500V SURFACE MOUNT CERAMIC CHIP CAPACITOR
C17	100 pF ATC 100B SURFACE MOUNT CERAMIC CHIP CAPACITOR
C16, C12, C11,C1	47 pF ATC 100B SURFACE MOUNT CERAMIC CHIP CAPACITOR
C15	10 μF / 50V ALUMINIUM ELECTROLYTIC RADIAL LEAD CAPACITOR
C13	100 pF ATC 700B SURFACE MOUNT CERAMIC CHIP CAPACITOR
C9, C2	0.8-8.0 pF GIGA TRIM VARIABLE CAPACITOR
C8	6.2 pF ATC 100B SURFACE MOUNT CERAMIC CHIP CAPACITOR
C7, C6, C5 ,C4	10 pF ATC 100B SURFACE MOUNT CERAMIC CHIP CAPACITOR
C3	3 pF ATC 100B SURFACE MOUNT CERAMIC CHIP CAPACITOR
R3	120 0-IM, 2W SURFACE MOUNT CERAMIC CHIP CAPACITOR
R2	4.7 M OHM 1W SURFACE MOUNT CERAMIC CHIP CAPACITOR
R1	18 K OHM, 1W SURFACE MOUNT CERAMIC CHIP CAPACITOR
FB2, FB1	SHIELD BEAD SURFACE MOUNT EMI
L2, L1	INDUCTOR, 5 TURNS AIR WOUND #22AWG, ID=0.059[1.49], NYLON COATED MAGNET WIRE
PCB	WOVEN FIBERGLASS REINFORCED PTFE 0.080" THK, ϵ r=2.55, 2 Oz EDCu BOTH SIDE



Text circuit layout SD57030

Text circuit layout 5

Figure 7. **Test fixture**

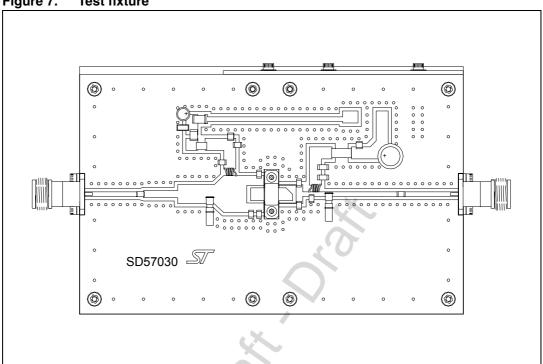
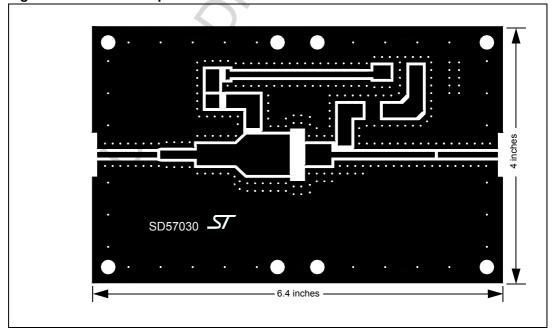


Figure 8. Test circuit photomaster



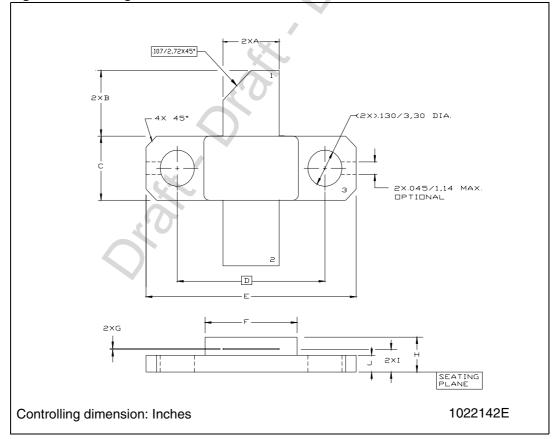
11 / 14

6 Package mechanical data

Table 6. M243 (.230 x .360 2L N/HERM W/FLG) mechanical data

Dim.	mm.				Inch	
	Min	Тур	Max	Min	Тур	Max
Α	5.21		5.72	0.205		0.225
В	5.46		6.48	0.215		0.255
С	5.59		6.10	0.220		0.240
D		14.27			0.562	
Е	20.07		20.57	0.790		0.810
F	8.89		9.40	0.350		0.370
G	0.10		0.15	0.004		0.006
Н	3.18		4.45	0.125		0.175
I	1.83		2.24	0.072		0.088
J	1.27		1.78	0.050		0.070

Figure 9. Package dimensions





Revision history SD57030

7 Revision history

Table 7. Document revision history

Date	Revision	Changes
24-Mar-2003	5	First Issue.
11-Jul-2007	6	Document reformatted, added lead free info
24-Aug-2007	7	Cover page title updated



SD57030

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



11/11